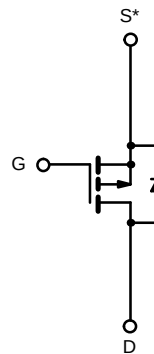
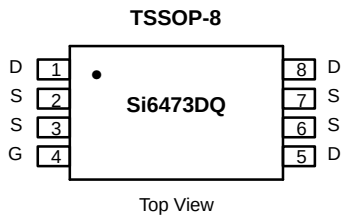




P-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY

V_{DS} (V)	$r_{DS(on)}$ (Ω)	I_D (A)
-20	0.0125 @ $V_{GS} = -4.5$ V	-9.5
	0.016 @ $V_{GS} = -2.5$ V	-8.5
	0.0215 @ $V_{GS} = -1.8$ V	-7.3

TrenchFET®
Power MOSFETs

* Source Pins 2, 3, 6 and 7 must be tied common.

P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS ($T_A = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)

Parameter		Symbol	10 secs	Steady State	Unit
Drain-Source Voltage		V _{DS}	−20		V
Gate-Source Voltage		V _{GS}	± 8		
Continuous Drain Current (T _J = 150°C) ^a	T _A = 25°C	I _D	−9.5	−6.2	A
	T _A = 70°C		−5.9	−4.9	
Pulsed Drain Current (10 μs Pulse Width)		I _{DM}	−30		
Continuous Source Current (Diode Conduction) ^a		I _S	−1.5	−0.95	W
Maximum Power Dissipation ^a	T _A = 25°C	P _D	1.75	1.08	
	T _A = 70°C		1.14	0.69	
Operating Junction and Storage Temperature Range		T _J , T _{stg}	−55 to 150		°C

THERMAL RESISTANCE RATINGS

Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^a	$t \leq 10$ sec	R_{thJA}	55	70	$^\circ\text{C/W}$
	Steady State		95	115	
Maximum Junction-to-Foot (Drain)	Steady State	R_{thJF}	35	45	

Notes

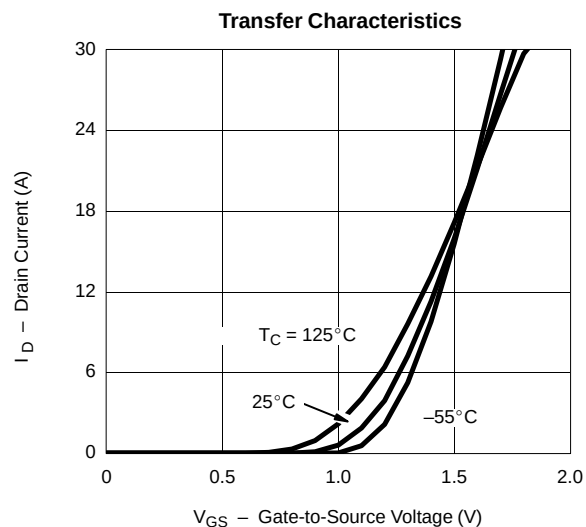
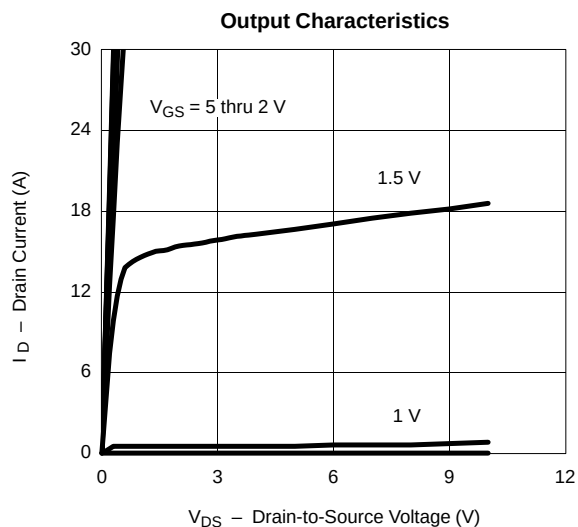
a. Surface Mounted on 1" x 1" FR4 Board.

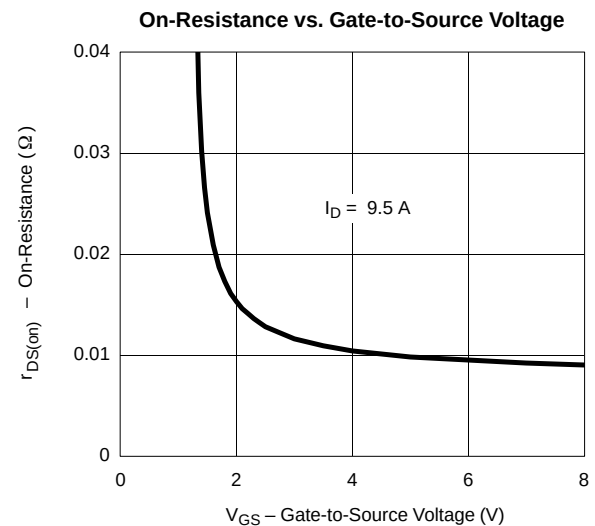
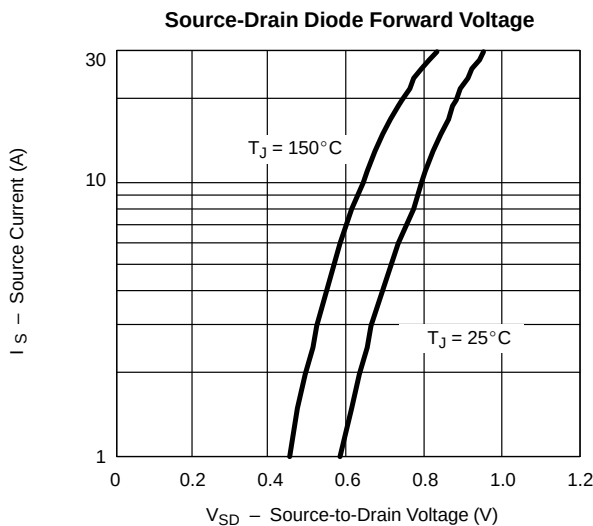
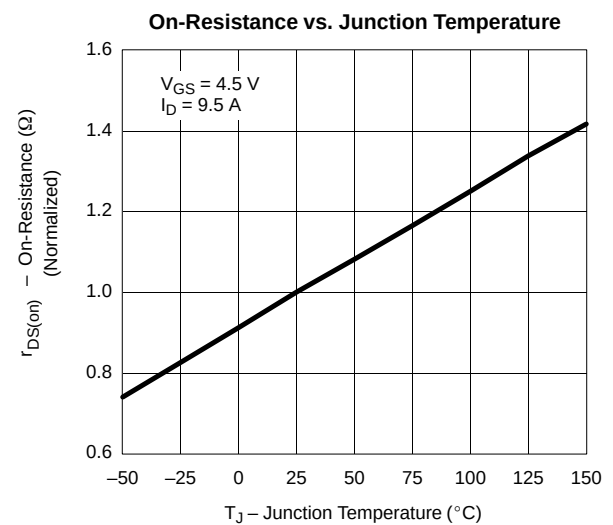
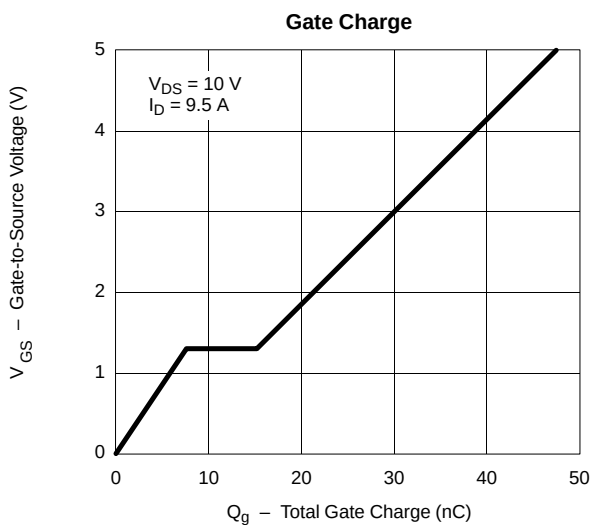
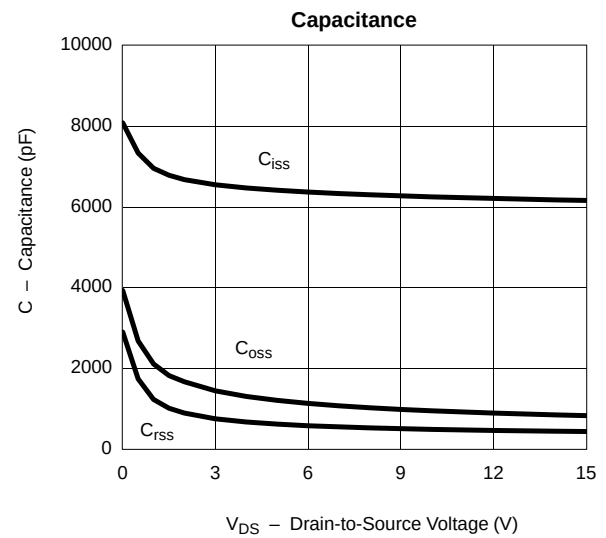
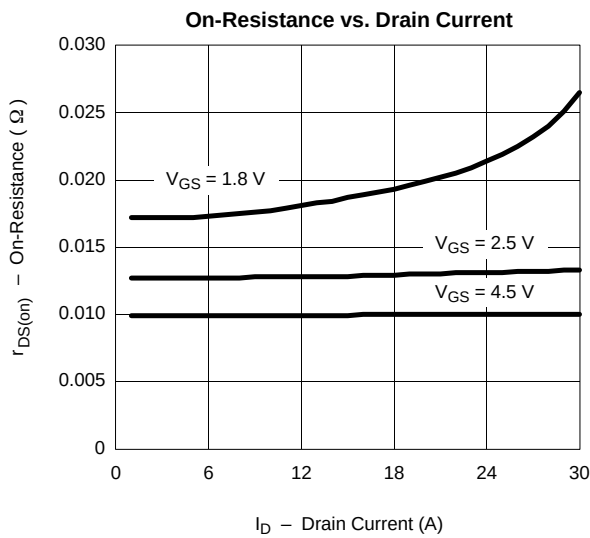
SPECIFICATIONS ($T_J = 25^\circ\text{C}$ UNLESS OTHERWISE NOTED)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Static						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$, $I_D = -250\ \mu\text{A}$	-0.45			V
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0\ \text{V}$, $V_{GS} = \pm 8\ \text{V}$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = -16\ \text{V}$, $V_{GS} = 0\ \text{V}$			-1	μA
		$V_{DS} = -16\ \text{V}$, $V_{GS} = 0\ \text{V}$, $T_J = 70^\circ\text{C}$			-10	
On-State Drain Current ^a	$I_{D(on)}$	$V_{DS} = -5\ \text{V}$, $V_{GS} = -4.5\ \text{V}$	20			A
Drain-Source On-State Resistance ^a	$r_{DS(on)}$	$V_{GS} = -4.5\ \text{V}$, $I_D = -9.5\ \text{A}$		0.010	0.0125	Ω
		$V_{GS} = -2.5\ \text{V}$, $I_D = -8.5\ \text{A}$		0.013	0.016	
		$V_{GS} = -1.8\ \text{V}$, $I_D = -7.5\ \text{A}$		0.0175	0.0215	Ω
Forward Transconductance ^a	g_{fs}	$V_{DS} = -15\ \text{V}$, $I_D = -9.5\ \text{A}$		45		S
Diode Forward Voltage ^a	V_{SD}	$I_S = -1.5\ \text{A}$, $V_{GS} = 0\ \text{V}$		-0.64	-1.1	V
Dynamic^b						
Total Gate Charge	Q_g	$V_{DS} = -10\ \text{V}$, $V_{GS} = -5\ \text{V}$, $I_D = -9.5\ \text{A}$		47.5	70	nC
Gate-Source Charge	Q_{gs}			7.6		
Gate-Drain Charge	Q_{gd}			7.6		
Turn-On Delay Time	$t_{d(on)}$	$V_{DD} = -10\ \text{V}$, $R_L = 15\ \Omega$ $I_D \approx -1\ \text{A}$, $V_{GEN} = -4.5\ \text{V}$, $R_G = 6\ \Omega$		42	60	ns
Rise Time	t_r			33	50	
Turn-Off Delay Time	$t_{d(off)}$			220	330	
Fall Time	t_f			95	140	
Source-Drain Reverse Recovery Time	t_{rr}	$I_F = -1.5\ \text{A}$, $di/dt = 100\ \text{A}/\mu\text{s}$		50	80	

Notes

- a. Pulse test; pulse width $\leq 300\ \mu\text{s}$, duty cycle $\leq 2\%$.
b. Guaranteed by design, not subject to production testing.

TYPICAL CHARACTERISTICS (25°C UNLESS NOTED)

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